

## **DATASHEET**

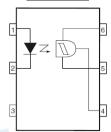
# 6 PIN DIP SCHMITT TRIGGER PHOTOCOUPLER H11LX Series



#### Features:

- High data rate, 1MHz typical (NRZ)
- Free from latch up and oscillation throughout voltage and temperature ranges.
- Microprocessor compatible drive
- Logic compatible output sinks 16mA at 0.4V maximum
- Guaranteed on/off threshold hysteresis
- Wide supply voltage capability, compatible with all popular logic systems
- High isolation voltage between input and output (Viso=5000 V rms)
- Compact dual-in-line package
- •The product itself will remain within RoHS compliant version
- •Compliance with EU REACH
- UL and cUL approved(No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved

## **Schematic**



## Pin Configuration

- 1. Anode
- 2. Cathode
- 3. No Connection
- 4. V<sub>O</sub>
- 5. GND
- 6. V<sub>CC</sub>

## Truth Table

Input	Output
Н	L
L	Н

## Description

The H11LX series of devices each consist of a GaAs infrared emitting diode optically coupled a high speed integrated circuit detector. The output detector incorporates a Schmitt trigger, which provides hysteresis for noise immunity and pulse shaping.

The devices are in a 6-pin DIP package and available in wide-lead spacing and SMD option.

## **Applications**

- Logic to logic isolator
- Programmable current level sensor
- Line receiver eliminate noise and transient problems
- AC to TTL conversion square wave shaping
- Digital programming of power supplies
- Interfaces computers with peripherals



## **Absolute Maximum Ratings (Ta=25°C)**

	Parameter	Symbol	Rating	Unit
Input	Forward current	I <sub>F</sub>	60	mA
	Reverse voltage	$V_{R}$	6	V
	Power dissipation	$P_{D}$	120	mW
Output	V <sub>45</sub> Allowed Range	Vo	0 to 16	V
	V <sub>65</sub> Allowed Range	V <sub>CC</sub>	3 to 16	V
	Output Current	I <sub>o</sub>	50	mA
	Power dissipation	P <sub>D</sub>	150	mW
Total power	dissipation	P <sub>tot</sub>	250	mW
Isolation voltage		V <sub>iso</sub>	5000	V rms
Operating temperature		T <sub>opr</sub>	-55~+100	°C
Storage temperature		T <sub>stg</sub>	-55~+150	°C
Soldering temperature *2		T <sub>sol</sub>	260	°C

## Notes:

**Electro-Optical Characteristics (Ta=25°C unless specified otherwise)** 

<sup>\*1</sup> AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

<sup>\*2</sup> For 10 seconds



## Input

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Forward Voltage	$V_{F}$	-	1.15	1.5	V	I <sub>F</sub> = 10mA
Reverse Current	I <sub>R</sub>	-	-	10	μA	V <sub>R</sub> = 5V
Input capacitance	CJ	-	-	100	pF	V=0, f=1MHz

## Output

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Operation Voltage Range	V <sub>CC</sub>	3	-	15	V	
Supply Current	$I_{CC(off)}$	-	1.6	5	mA	I <sub>F</sub> =0mA, Vcc=5V
Output Current, High	I <sub>OH</sub>	-	-	100	μA	I <sub>F</sub> =0mA, Vcc=Vo=15V
Isolation Resistance	R <sub>ISO</sub>	10 <sup>11</sup>	-	-	Ω	V <sub>I-O</sub> =500VDC

## **Transfer Characteristics**

Parameter	Symbol	Min	Тур.	Max.	Unit	Condition	
Supply Current	I <sub>CC(on)</sub>	-	1.6	5	mA	I <sub>F</sub> =10mA, Vcc=5V	
Output Voltage .low	V <sub>OL</sub>		-	0.4	V	Vcc=5V, $I_F=I_{Fon}(max.)$ , $R_L=270\Omega$	
Turn on H11L1				1.6			
Threshold H11L2	I <sub>Fon</sub>	_	-	10	mA	Vcc=5V, $R_L$ =270 $\Omega$	
Current <sup>1</sup> H11L3		-	-	5			
Turn off Threshold Current	I <sub>Foff</sub>	-	1	-	mA	Vcc=5V, $R_L$ =270 $\Omega$	
Hysteresis Ratio	I <sub>Foff</sub> /I <sub>Fon</sub>	0.5	-	0.9		Vcc=5V, $R_L$ =270 $\Omega$	
Turn on Time	t <sub>on</sub>	-	-	4	μS		
Fall Time	t <sub>r</sub>	-	0.1	-	μS	Vcc=5V,	
Turn off Time	t <sub>off</sub>	-	-	4	μS	I <sub>F</sub> =I <sub>Fon</sub> , R <sub>L</sub> =270Ω	
Rise Time	t <sub>r</sub>	-	0.1	-	μS		
Data Rate		-	1	-	MHz		

## **Typical Electro-Optical Characteristics Curves**

<sup>\*</sup> Typical values at  $T_a = 25$ °C <sup>1</sup>. Max.  $I_{F(ON)}$  is the maximum current required to trigger the output. For examples, a 1.6mA maximum trigger current would require the LED to be driven at a current greater than 1.6mA to guarantee the device will turn on. A 10% guard band is recommended to account for degradation of the LED over its lifetime. The maximum allowable LED drive current is 60mA.



Figure 1. Forward Current vs Forward Voltage

100

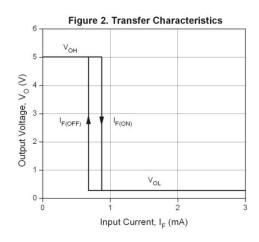
T<sub>A</sub> = 25°C

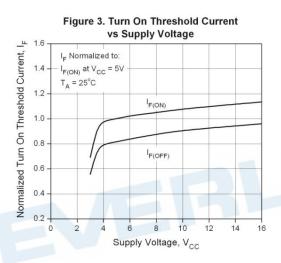
T<sub>A</sub> = 100°C

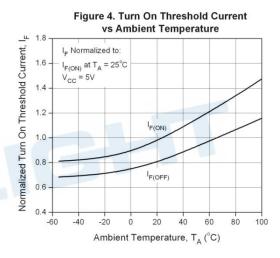
T<sub>A</sub> = -55°C

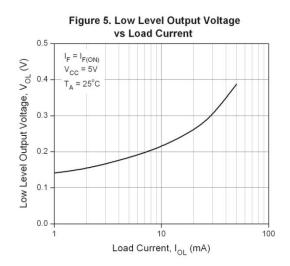
T<sub>A</sub> = -55°C

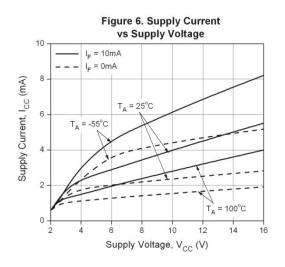
T<sub>A</sub> = -55°C











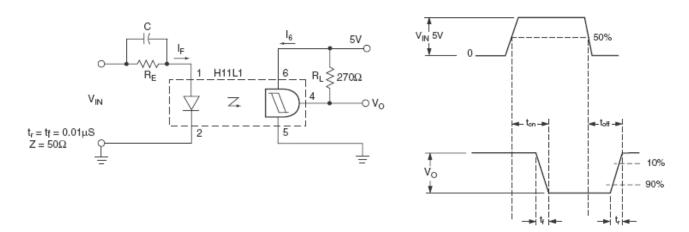


Figure 7. Switching Time Test Circuit & Waveforms

## **Order Information**

## **Part Number**

## H11LXY(Z)-V

## <u>Note</u>

 $\overline{X}$  = Part No. for 1, 2 or 3

Y = Lead form option (S, S1, M or none)

Z = Tape and reel option (TA, TB or none).

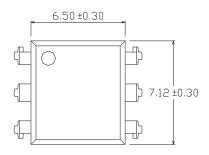
Z = Tape and reel V = VDE (optional)

Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
М	Wide lead bend (0.4 inch spacing)	65 units per tube
S + TA	Surface mount lead form + TA tape & reel option	1000 units per reel
S + TB	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 + TA	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 + TB	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

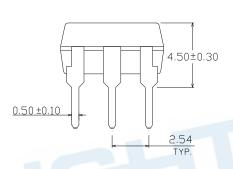


## Package Dimension (Dimensions in mm)

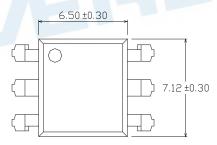
## **Standard DIP Type**

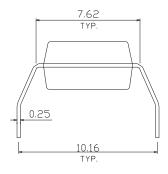


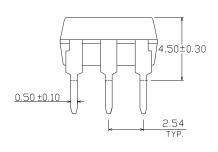




## **Option M Type**

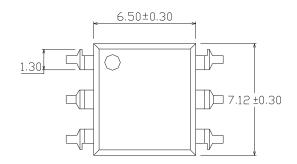


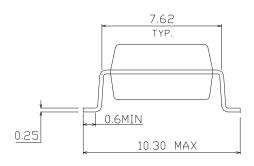


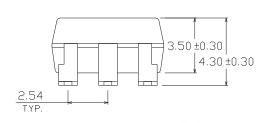




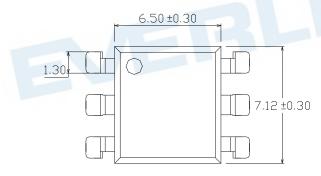
## **Option S Type**

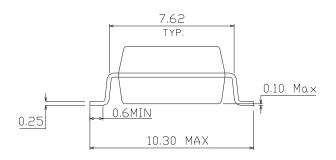


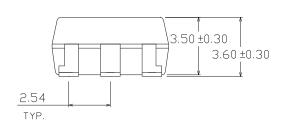




## **Option S1 Type**

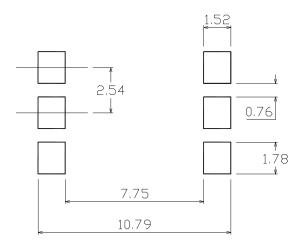




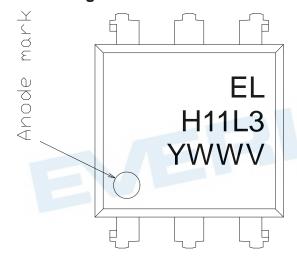




## Recommended pad layout for surface mount leadform



## **Device Marking**



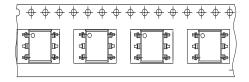
#### **Notes**

EL denotes Everlight
H11L3 denotes Device Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE (optional)



## **Tape & Reel Packing Specifications**

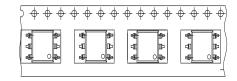
## **Option TA**



Direction of feed from reel



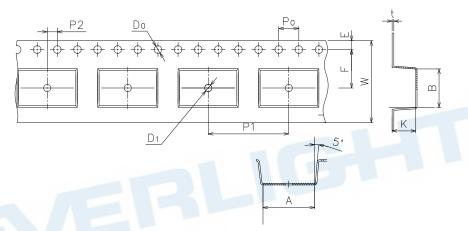
## **Option TB**



Direction of feed from reel



## **Tape dimensions**



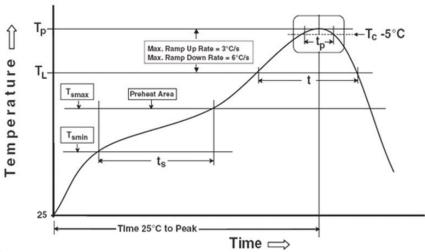
Dimension No.	А	В	Do	D1	E	F
Dimension(mm)	10.8±0.1	7.55±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	W	К
Dimension(mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1



## **Precautions for Use**

## 1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

3 °C/second max

#### **Preheat**

Temperature min  $(T_{smin})$  150 °C Temperature max  $(T_{smax})$  200°C Time  $(T_{smin} \text{ to } T_{smax})$   $(t_s)$  60-120 seconds

Average ramp-up rate (T<sub>smax</sub> to T<sub>p</sub>)

## Other

Liquidus Temperature ( $T_L$ )

217 °C

Time above Liquidus Temperature ( $t_L$ )

60-100 sec

Peak Temperature ( $T_P$ )

260°C

Time within 5 °C of Actual Peak Temperature:  $T_P$  - 5°C

30 s

Ramp- Down Rate from Peak Temperature 6°C /second max.

Time 25°C to peak temperature 8 minutes max.

Reflow times 3 times



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